

## Model: FXO-HC32 SERIES

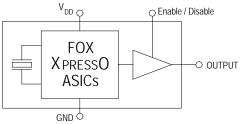
# HCMOS 3.2 x 2.5mm 2.5V Oscillator

#### Freq: 0.75 MHz to 180MHz

Rev.09/05/2008

#### Features

- ۲ XTREMELY Low Jitter
- Low Cost
- XPRESS Delivery
- Frequency Resolution to six decimal places
- Stabilities to ± 50 PPM
- -20 to +70°C or -40 to +85°C operating temperatures
- Tri-State Enable / Disable Feature
- Industry Standard Package, Footprint & Pin-Out
- Fully RoHS compliant
- Gold over Nickel Termination Finish
- Serial ID with Comprehensive Traceability



For more information -- Click on the drawing

## **Description**

The Fox XPRESSO Crystal Oscillator is a breakthrough in configurable Frequency Control Solutions. XPRESSO utilizes a family of proprietary ASICs, designed and developed by Fox, with a key focus on noise reduction technologies.

The 3<sup>rd</sup> order Delta Sigma Modulator reduces noise to the levels that are comparable to traditional Bulk Quartz and SAW oscillators. The ASICs family has ability to select the output type, input voltages, and temperature performance features.

With the XPRESS lead-time, low cost, low noise, wide frequency range, excellent ambient performance, XpressO is an excellent choice over the conventional technologies.

Finished XPRESSO parts are 100% final tested.







## **Applications**

- ANY application requiring an oscillator
- SONET
- Ethernet
- Storage Area Network
- **Broadband Access**
- Microprocessors / DSP / FPGA
- Industrial Controllers
- Test and Measurement Equipment
- Fiber Channel

## Contents

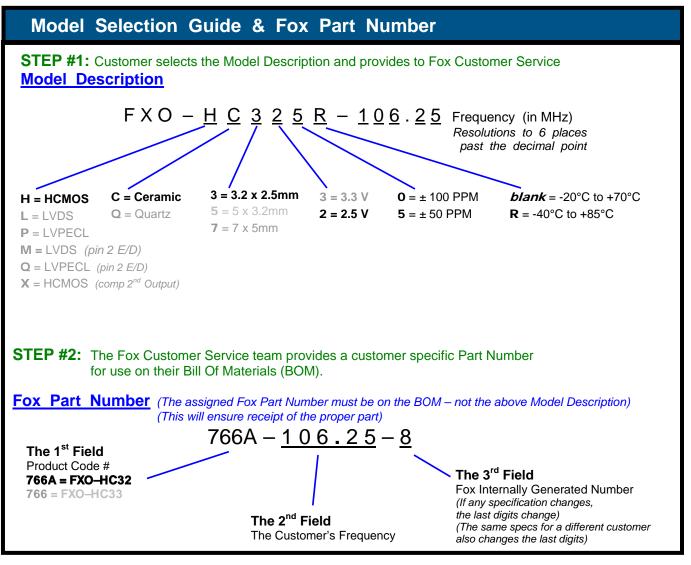
	page
Model Selection & Part Number Guide	2
Electrical Characteristic	3
Absolute Maximums	4
Output Wave Characteristics	4
Phase Noise	5
Jitter	5
Pin Assignment	6
Recommended Circuit	6
Reflow	6
Mechanical Drawing and Pad Layout	7
Tape and Reel Specification	8
Label	8
Traceability - LOT Number & Serial Identificati	on 9
SGS Report	10~13
Mechanical Test	14
Burn-In Test	14
MTTF / FITS calculations	15
Fox Contact Information	16

FOXElectronics 5570 Enterprise Parkway Fort Myers, Florida 33905 USA +1.239.693.0099 FAX +1.239.693.1554 http://www.foxonline.com EMEA Tel/Fax: +44 .1767.312632 | Asia Hong Kong Tel: +852.2854.4285 Fax +852.2854.4282 Japan Tel: +81.3.3374.2079 Fax: +81.3.3374.5221 © 2008 FOX ELECTRONICS | ISO9001:2000 Certified

Page 1 of 16







This example, FXO-HC325R-106.25 = HCMOS Output, Ceramic 3.2 x 2.5mm Package, 2.5V, ±50 PPM Stability, -40 to +85°C Temperature Range, at 106.25 MHz





Electrical Characteristics			
Parameters	Symbol	Condition	Maximum Value (unless otherwise noted)
Frequency Range	Fo		0.750 to 180.000 MHz
Frequency Stability <sup>1</sup>			100, 50 ppm
Temperature Range	Т <sub>о</sub> Т <sub>sтg</sub>	Standard operating <i>Optional operating</i> Storage	-20°C to +70°C -40°C to +85°C -55°C to +125°C
Supply Voltage	V <sub>DD</sub>	Standard	2.5 V ± 5%
Input Current (@ 15pF LOAD)	I <sub>DD</sub>	0.75 ~ 20 MHz 20+ ~ 50 MHz 50+ ~ 100 MHz 100+ ~ 130 MHz 130+ ~ 160 MHz 160+ ~ 180 MHz	22 mA 25 mA 29 mA 32 mA 35 mA 37 mA
Output Load	HCMOS	Standard	15 pF
Start-Up Time	Ts		10 mS
Output Enable / Disable Time			100 nS
Moisture Sensitivity Level	MSL	JEDEC J-STD-20	1
Termination Finish			Au

Note 1 - Stability is inclusive of 25°C tolerance, operating temperature range, input voltage change, load change, aging, shock and vibration.

Absolute Maximum Ratings (Useful life may be impaired. For user guidelines only, not tested) Operation is only guaranteed for voltage and temperature specifications in Electrical Characteristics section.)

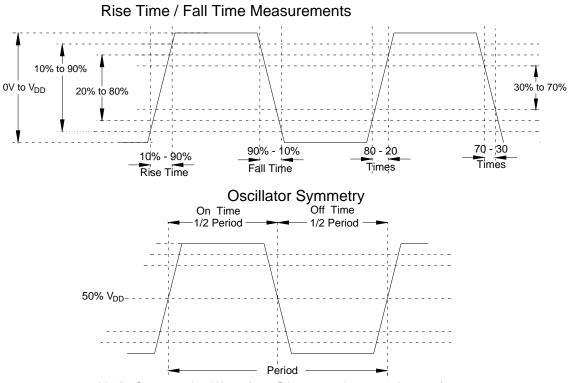
Parameters	Symbol	Condition	Maximum Value (unless otherwise noted)
Input Voltage	V <sub>DD</sub>		–0.5V to +5.0V
Operating Temperature	T <sub>AMAX</sub>		–55°C to +105°C
Storage Temperature	T <sub>STG</sub>		–55°C to +125°C
Junction Temperature			150°C
ESD Sensitivity	HBM	Human Body Model	> 1 kV





Output Wave Charac	Output Wave Characteristics				
Parameters	Symbol	Condition	Maximum Value (unless otherwise noted)		
Output LOW Voltage	V <sub>OL</sub>	0.75 to 160 MHz 160+ to 180 MHz	10% V <sub>DD</sub> 20% V <sub>DD</sub>		
Output HIGH Voltage	V <sub>он</sub>	0.75 to 160 MHz 160+ to 180 MHz	90% V <sub>DD</sub> MIN 80% V <sub>DD</sub> MIN		
Output Symmetry (See Drawing Below)		@ 50% V <sub>DD</sub> Level	45% ~ 55%		
Output Enable (PIN # 1) Voltage	V <sub>IH</sub>		≥ 70% V <sub>DD</sub>		
Output Disable (PIN # 1) Voltage	VIL		≤ 30% V <sub>DD</sub>		
Cycle Rise Time (See Drawing Below)	T <sub>R</sub>	0.75 to 160 MHz 160+ to 180 MHz	3.5 nS (10%-90%) 2.5 nS (20%-80%)		
Cycle Fall Time (See Drawing Below)	T <sub>F</sub>	0.75 to 160 MHz 160+ to 180 MHz	3.5 nS (90%~10%) 2.5 nS (80%~20%)		

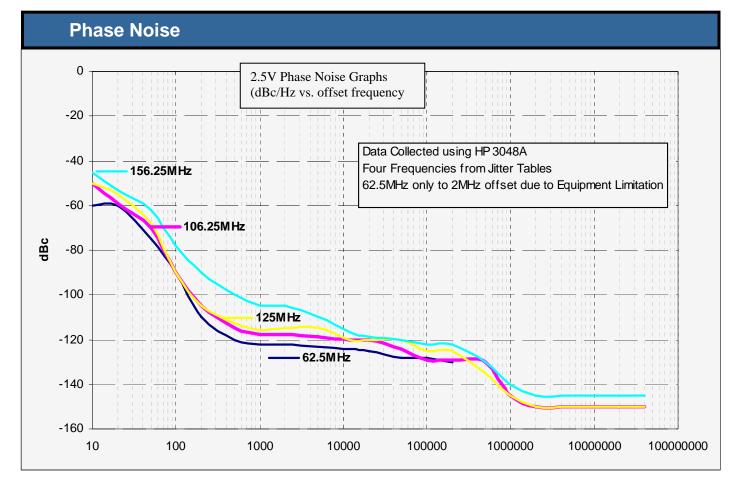
If 30% to 70% times are used, Rise and Fall times change to 2 nS from 0.75 to 180MHz If 20% to 80% times are used, Rise and Fall times change to 2.5 nS from 0.75 to 160MHz



Ideally, Symmetry should be 50/50 -- Other expressions are 45/55 or 55/45







Jitter is frequency dependent. Below are typical values at select frequencies.

Phase Jitter & Time Interval Error (TIE)					
Frequency	Phase JitterT I EFrequency(12kHz to 20MHz)(Sigma of Jitter Distribution)		Units		
62.5 MHz	0.9	2.9	pS RMS		
106.25 MHz	0.8	3.5	pS RMS		
125 MHz	0.8	2.5	pS RMS		
156.25 MHz	0.9	3.1	pS RMS		

<u>Phase Jitter</u> is integrated from HP3048 Phase Noise Measurement System; measured directly into 50 ohm input;  $V_{DD} = 2.5V$ . <u>TIE</u> was measured on LeCroy LC684 Digital Storage Scope, directly into 50 ohm input, with Amherst M1 software;  $V_{DD} = 2.5V$ . *Per MJSQ spec (Methodologies for Jitter and Signal Quality specifications)* 

Random &	Random & Deterministic Jitter Composition					
Frequency	Random (Rj) (pS RMS)	Deterministic (Dj) (pS P-P)	Total Jitter (Tj) (14 x Rj) + Dj			
62.5 MHz	1.3	9.2	28.4 pS			
106.25 MHz	1.3	9.0	27.2 pS			
125 MHz	1.3	8.8	27.7 pS			
156.25 MHz	1.4	10.4	30.3 pS			

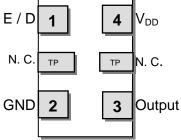
<u>**Ri and Di**</u>, measured on LeCroy LC684 Digital Storage Scope, directly into 50 ohm input, with Amherst M1 software. *Per* **MJSQ** spec (Methodologies for Jitter and Signal Quality specifications)

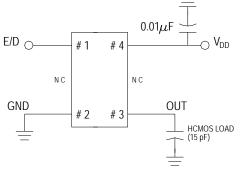






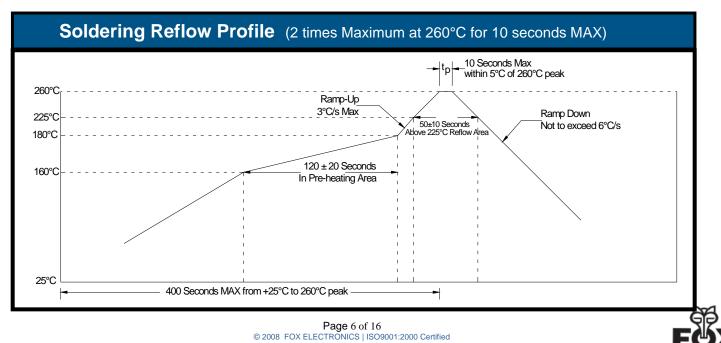
Pin #	Name	Туре	Function	
1	E/D <sup>1</sup>	Logic	Enable / Disable Control of Output (0 = Disabled)	
2	GND	Ground	Electrical Ground for V <sub>DD</sub>	
3	Output	Output	HCMOS Oscillator Output	
4	V <sub>DD</sub> <sup>2</sup>	Power	Power Supply Source Voltage	
Test Points	N. C.	Hi Z	No Connection (Factory Use ONLY)	
<ul> <li>NOTES:         <ol> <li>Includes pull-up resistor to V<sub>DD</sub> to provide output when the pin (1) is No Connect.</li> </ol> </li> <li>Installation should include a 0.01µF bypass capacitor placed between V<sub>DD</sub> (Pin 4) and GND (Pin 2) to minimize power supply line noise.</li> </ul>				





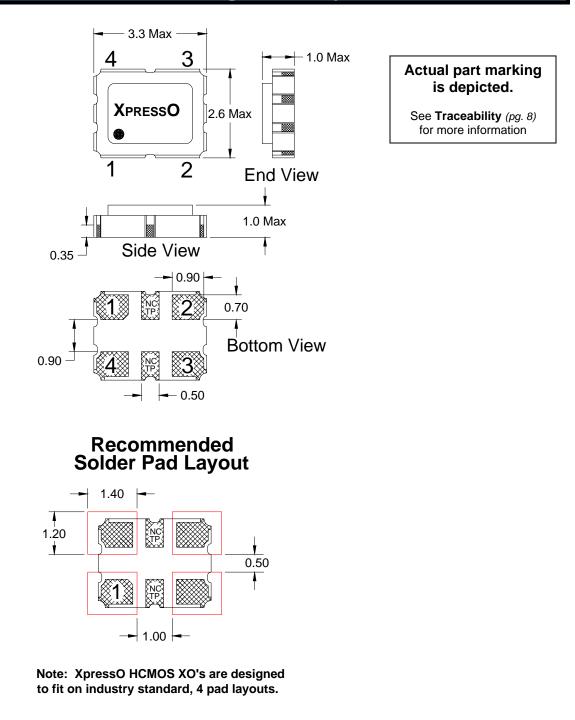
Terminations as viewed from the Top NOTE: XPRESSO HCMOS XOs are designed to fit on Industry Standard, 4 pad layouts

Enable / Disable Control				
Pin # 1 (state)	Output (Pin # 3)			
OPEN (No Connection)	ACTIVE Output			
"1" Level V <sub>IH</sub> ≥70% V <sub>DD</sub>	ACTIVE Output			
"0" Level $V_{IL} \le 30\% V_{DD}$	High Impedance			





## Mechanical Dimensional Drawing & Pad Layout



#### Pin Connections

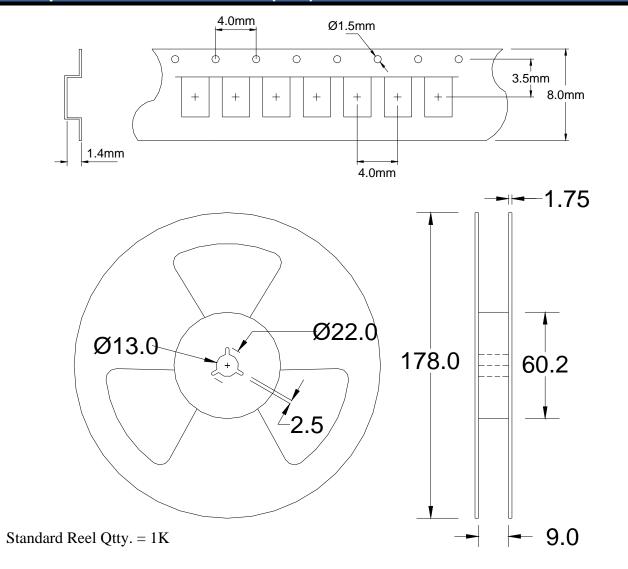
#1 E/D	#3 V <sub>OUT</sub>
#2 GND	#4 $V_{DD}$

Drawing is for reference to critical specifications defined by size measurements. Certain non-critical visual attributes, such as side castellations, reference pin shape, etc. may vary





## Tape and Reel Dimensions (mm)





An additional identification code is contained internally if tracking should ever be necessary



Downloaded from Elcodis.com electronic components distributor



## Traceability – LOT Number & Serial Identification

#### **LOT Number**

The LOT Number has direct ties to the customer purchase order. The LOT Number is marked on the "Reel" label, and also stored internally on non-volatile memory inside the XPRESSO part. XPRESSO parts that are shipped Tape and Reel, are also placed in an Electro Static Discharge (ESD) bag and will have the LOT Number labeled on the exterior of the ESD bag.

It is recommended that the XPRESSO parts remain in this ESD bag during storage for protection and identification.

If the parts become separated from the label showing the LOT Number, it can be retrieved from inside one of the parts, and the information that can be obtained is listed below:

- Customer Purchase Order Number
- Internal Fox Sales Order Number
- Dates that the XPRESSO part was shipped from the factory
- The assigned customer part number
- The specification that the part was designed for

#### **Serial Identification**

The Serial ID is the individualized information about the configuration of that particular XPRESSO part. The Serial ID is unique for each and every XPRESSO part, and can be read by special Fox equipment.

With the Serial ID, the below information can be obtained about that individual, XPRESSO part:

- Equipment that the XPRESSO part was configured on
- Raw material used to configure the XPRESSO part
- Traceability of the raw material back to the foundries manufacturing lot
- Date and Time that the part was configured
- Any optimized electrical parameters based on customer specifications
- Electrical testing of the actual completed part
- Human resource that was monitoring the configuration of the part

Fox has equipment placed at key Fox locations World Wide to read the Lot Identification and Serial Number of any XPRESSO part produced and can then obtain the information from above within 24 hours.





# 3<sup>rd</sup> Party (SGS) Material Report **Test Report** No.: CE/2008/63138 Date: 2008/06/19 Page: 1 of 4 FOX ELECTRONICS 5570 ENTERPRISE PARKWAY FT, MYERS, FL 33905, USA The following sample(s) was/were submitted and identified by/on behalf of the client as : : XPRESSO CERAMIC OSCILLATORS Sample Description Style/Item No. : SEAM SEAL CLOCK OSCILLATOR Buyer/Order No. 47454 : : 2008/06/12 Sample Receiving Date : 2008/06/12 TO 2008/06/19 Testing Period Test Result(s) : Please refer to next page(s). Chenyu Kung / Operation Manager Signed for and on behalf of SGS TAIWAN LTD. Chemical Laboratory - Taipei Unless otherwise stated the results shown in this test report refer only to the sample(s) tested. This test report cannot be reproduced, except in full, without prior written permission of the Company. 除非均有按照, 此能告结果做主的就之情是自意,不能在主机本之间着面部行可,不可愿的规模。 This Test Report is issued by the Company under its General Conditions of Service printed overleaf or available on request and accessible at <u>antipulway second-tems</u>, and <u>conditions tim</u>. Attention is drawn to the limitation of liability, indemrification and jurisdiction issues defined therein. Any holder of this Test Report is advised that information contained hereion refeds the Company's indings at the time of its information contained herein and his document daes not exonerate particles to a transaction document daes not exonerate particles to a transaction form exercising all their rights and obligations under the transaction documents. Any unauthorized ateration, forgery or taisfication of the content or appearance of this document is unawful and offenders may be prosecuted to the fulliest extert of the law. SGS Taiwan Ltd. No. 33 Wu Chyuan Road, Wuku Industrial Zone, Taipel County, Taiwan / 台北縣五股工 樂高五欄路 33 號 t (885-2) 2299-3939 台灣檢驗科技股份有限公司 www.tw.sgs.com f(886-2) 2299-3237 Member of the SGS Group





#### FXO-HC32 Series

#### 3<sup>rd</sup> Party (SGS) Material Report **Test Report** No.: CE/2008/63138 Date: 2008/06/19 Page: 2 of 4 FOX ELECTRONICS 5570 ENTERPRISE PARKWAY FT. MYERS, FL 33905, USA Test Result(s) PART NAME NO.1 : MIXED ALL PARTS Result MDL Test Item (s): Unit Method No.1 Cadmium (Cd) mg/kg With reference to IEC 62321/2nd 2 n.d. CDV (111/95/CDV). Determination of Cadmium by ICP-AES. With reference to IEC 62321/2nd Lead (Pb) mg/kg 2 n.d. CDV (111/95/CDV). Determination of Lead by ICP-AES With reference to IEC 62321/2nd 2 Mercury (Hg) mg/kg n.d. CDV (111/95/CDV). Determination of Mercury by ICP-AES. Hexavalent Chromium Cr(VI) by With reference to IEC 62321/2nd mg/kg 2 n.d. alkaline extraction CDV (111/95/CDV). Determination of Hexavalent Chromium for nonmetallic samples by UV/Vis Spectrometry Halogen ----With reference to BS EN 14582:2007. Analysis was performed by IC method for F , CI , Br, I content Halogen-Fluorine (F) mg/kg With reference to BS EN 50 n.d. 14582:2007. Analysis was performed (CAS No.: 007782-41-4) by IC method for Fluorine content. Halogen-Chlorine (CI) mg/kg With reference to BS EN 50 n.d. 14582:2007. Analysis was performed (CAS No.: 007782-50-5) by IC method for Chlorine content. Halogen-Bromine (Br) With reference to BS EN 50 mg/kg n.d. (CAS No.: 007726-95-6) 14582:2007. Analysis was performed by IC method for Bromine content. Halogen-lodine (I) mg/kg With reference to BS EN 50 n.d. (CAS No.: 007553-56-2) 14582:2007. Analysis was performed by IC method for lodine content. Unless otherwise stated the results shown in this test report refer only to the sample(s) tested. This test report cannot be reproduced, except in full, without prior written permission of the Company. 能用有我的,他用些高潮做到的意义就是自我。本确告来都本公司書面許可,不可能的根理。 This Test Report is issued by the Company under its General Conditions of Service printed overleaf or available on request and accessible at <u>http://www.gos.com/lems\_ant\_conditions.thm</u>. Attention is drawn to the limitation of liability, indemnification and jurisdiction issues defined therein. Any holder of this Test Report is advised that information contained hereon refeats the Company's noting at the time of its intervention only and within the limits of Client's instructions; if any. The Company's sole exponsibility is to its Client and this document does not excercise parties to a transaction from exercising all first ingitise transaction of the content or appearance of this document is unlawful and offenders may be prosecuted to the fullest extent of the law.

SGS Taiwan Ltd. No. 33 Wu Chyuan Road, Wuku Industrial Zone, Taipel County, Taiwan / 台北解五股工樂面五欄路 33號 t (885-2) 2299-3939 f(886-2) 2299-3237 台灣檢驗科技股份有限公司 www.tw.sos.com

Member of the SGS Group



Page 11 of 16 © 2008 FOX ELECTRONICS | ISO9001:2000 Certified



#### 3<sup>rd</sup> Party (SGS) Material Report



## **Test Report**

No.: CE/2008/63138 Date: 2008/06/19 Page: 3 of 4

FOX ELECTRONICS

5570 ENTERPRISE PARKWAY FT. MYERS, FL 33905, USA

Test Item (s):	Unit	Method	MDL	Result
	Unit	metrod	MDL	No.1
Sum of PBBs			2 <b>.</b> -	n.d.
Monobromobiphenyl		Ι Γ	5	n.d.
Dibromobiphenyl		I E	5	n.d.
Tribromobiphenyl	1	I F	5	n.d.
Tetrabromobiphenyl	1	I E	5	n.d.
Pentabromobiphenyl	1	Ι Γ	5	n.d.
Hexabromobiphenyl	1	I F	5	n.d.
Heptabromobiphenyl	1	I F	5	n.d.
Octabromobiphenyl	1	Ι Γ	5	n.d.
Nonabromobiphenyl	mg/kg	I F	5	n.d.
Decabromobiphenyl		With reference to IEC 62321/2nd CDV (111/95/CDV). Determination of PBB and PBDE by GC/MS.	5	n.d.
Sum of PBDEs (Mono to Nona)			-	n.d.
Monobromodiphenyl ether			5	n.d.
Dibromodiphenyl ether	1		5	n.d.
Tribromodiphenyl ether	1		5	n.d.
Tetrabromodiphenyl ether	]	Ι Γ	5	n.d.
Pentabromodiphenyl ether	1		5	n.d.
Hexabromodiphenyl ether	1	I F	5	n.d.
Heptabromodiphenyl ether		I F	5	n.d.
Octabromodiphenyl ether		Ι Γ	5	n.d.
Nonabromodiphenyl ether			5	n.d.
Decabromodiphenyl ether			5	n.d.
Sum of PBDEs (Mono to Deca)	1	I 1		n.d.

Note : 1. mg/kg = ppm

2. n.d. = Not Detected

3. MDL = Method Detection Limit

4. "---" = Not Conducted

5. " - " = Not Regulated

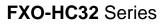
6. The sample(s) was/were analyzed on behalf of the applicant as mixing sample in one testing. The above result(s) was/were only given as the informality value.

Unless otherwise stated the results shown in this test report refer only to the sample(s) tested. This test report cannot be reprodute Company. 除非另有說明。此報告結果僅對現試之樣品負責。本報告未經本公司書面許可。不可認份複製。	iced, except in full, without prior written permission of
This Test Report is issued by the Company under its General Conditions of Service printed overleaf	or available on request and accessible at
http://www.sgs.com/tems_and_conditions.htm. Attention is drawn to the limitation of liability, indemnification and jurisdiction is advised that information contained hereon reflects the Company's findings at the time of its intervention only and within the limits	s of Client's instructions, if any. The Company's sole
responsibility is to its Clent and this document does not exonerate parties to a transaction from exercising all their rights an unauthorized alteration, forgery or faisification of the content or appearance of this document is unlawful and offenders may be particular to the second	

SGS Taiwan Ltd. No. 33 Wu Chyuan Road, Wuku Industrial Zone, Taipel County, Taiwan / 台北解五股工業富五權路 33號 t (886-2) 2299-3939 台灣檢驗科技股份有限公司 f (886-2) 2299-3237 www.tw.sgs.com

Member of the SGS Group









© 2008 FOX ELECTRONICS | ISO9001:2000 Certified

DWG-5053



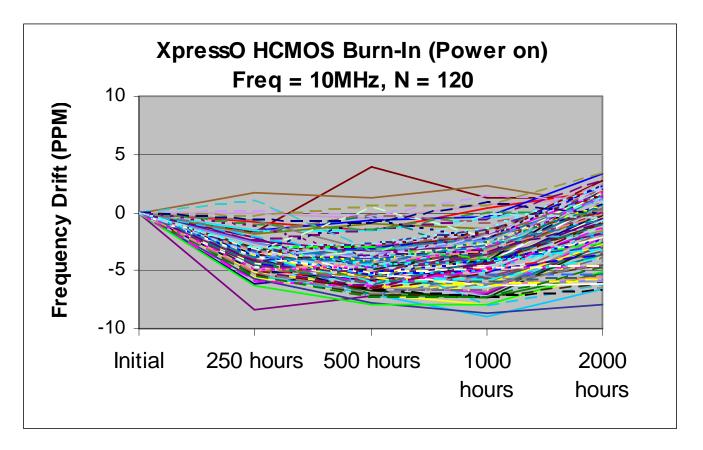


## **Mechanical Testing**

Parameter	Test Method
Mechanical Shock	Drop from 75cm to hardwood surface – 3 times
Mechanical Vibration	10~55Hz, 1.5mm amplitude, 1 Minute Sweep 2 Hours each in 3 Directions (X, Y, Z)
High Temperature Burn-in	Under Power @ 125°C for 2000 Hours (results below)
Hermetic Seal	He pressure: 4 $\pm$ 1 kgf / cm <sup>2</sup> 2 Hour soak

# 2,000 Hour Burn-In

#### Burn-In Testing – under power 2000 Hours, 125°C







#### **MTTF / FITS Calculations**

Products are grouped together by process for MTTF calculations. (All XpressO output and package types are manufactured with the same process)

Number of Parts Tested:<br/>Number of Failures:360 (120 of each output type: HCMOS, LVDS, LVPECL)Number of Failures:<br/>Test Temperature:125°CNumber of Hours:<br/>20002000

MTTF was calculated using the following formulas:

[1.] Device Hours (devhrs) = (number of devices) x (hours at elevated temperature in °K)

 $[2.] MTTF = \frac{devhrs \times af \times 2}{\chi^2}$ 

[3.] FITS =  $\frac{1}{MTTF}$  \* 10<sup>9</sup>

Where:

Label	Name	Formula/Value
af	Acceleration Factor	$\boldsymbol{\varrho}^{(\frac{eV}{k})\times(\frac{1}{t_1}-\frac{1}{t_2})}$
eV	Activation Energy	0.40 V
k	Bolzman's Constant	8.62 X 10⁻⁵ e <i>V</i> /ºK
t <sub>1</sub>		Operating Temperature (°K)
t <sub>2</sub>		Accelerated Temperature (°K)
Θ	Theta	Confidence Level (60% industry standard)
r	Failures	Number of failed devices
X <sup>2</sup>	Chi-Square	statistical significance for bivariate tabular analysis [table look- up] based on assumed $\Theta$ (Theta – confidence) and number of failures (r) For zero failures (60% Confidence): $\chi^2 = 1.830$

DEVICE-HOURS = 360 x 2000 HOURS = 720,000

ACCELERATION FACTOR =  $e^{(\frac{0.40}{8.625})\times(\frac{1}{298}-\frac{1}{398})} = 49.91009$ 

MTTF =  $\frac{720,000 \times 49.91009 \times 2}{1.833}$  = 39,209,238 Hours

Failure Rate =  $\frac{1.833}{720,000 \times 49.91009 \times 2}$  = 2.55E-8

FITS = Failure Rate \*1E9 = 26





#### Notes :

Patent Numbers: US 6,664,860, US 5,960,403, US 5,952,890; US 5,960,405; US 6,188,290; Foreign Patents: R.S.A. 98/0866, R.O.C. 120851; Singapore 67081, 67082; EP 0958652 China ZL 98802217.6, Malaysia MY-118540-A, Philippines 1-1998-000245, Hong Kong #HK1026079, Mexico #232179 US and Foreign Patents Pending XpressO® Fox Electronics

The above specifications, having been carefully prepared and checked, is believed to be accurate at the time of publication; however, no responsibility is assumed by Fox Electronics for inaccuracies.

#### **Contact Information**

(USA)-Worldwide Headquarters Tel: 888-GET-2-FOX Outside US: +1.239.693.0099, Fax: +1.239.693.1554 Fox Hong Kong Tel: +852.2854.4285, Fax: +852.2854.4282

Fox EMEA Tel/Fax: +44.1767.312632

Tel: +81.3.3374.2079, Fax: +81.3.3377.5221

Fox Japan

Page 16 of 16

